

Three-channel, Single-phase Power/Energy IC

GND: 0 V, VA+: +5 V, VD+: +3.3 V to +5 V

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1. OVERVIEW

The CS5464 is a CMOS power measurement integrated circuit utilizing four $\Delta \Sigma$ analog-to-digital converters to measure line voltage, temperature, and current from up to two sources. It calculates active, reactive, and apparent power as well as RMS and peak voltage and current. It handles other system-related functions, such as pulse output conversion, voltage sag, current fault, voltage zero crossing, line frequency, and tamper detection.

The CS5464 is optimized to interface to current transformers or shunt resistors for current measurement, and to a resistive divider or voltage transformer for voltage measurement. Two full-scale ranges are provided on the current inputs to accommodate both types of current sensors. The second current channel can be used for tamper detection or as a second current input. The CS5464's three differential inputs have a common-mode input range from analog ground (AGND) to the positive analog supply (VA+).

An additional analog input (PFMON) is provided to allow the application to determine when a power failure is in progress. By monitoring the unregulated power supply, the application can take any required action when a power loss occurs.

An on-chip voltage reference (nominally 2.5 volts) is generated and provided at analog output, VREFOUT. This reference can be supplied to the chip by connecting it to the reference voltage input, VREFIN. Alternatively, an external voltage reference can be supplied to the reference input.

Three digital outputs $(\overline{E1}, \overline{E2}, \overline{E3})$ provide a variety of output signals and, depending on the mode selected, provide energy pulses, power failure indication, or other choices.

The CS5464 includes a three-wire serial host interface to an external microcontroller or serial E²PROM. Signals include serial data input (SDI), serial data output (SDO), serial clock (SCLK), and optionally, a chip select (\overline{CS}) , which allows the CS5464 to share the SDO signal with other devices. A MODE input is used to control whether an E²PROM will be used instead of a host microcontroller.

2. PIN DESCRIPTION

3. CHARACTERISTICS & SPECIFICATIONS

RECOMMENDED OPERATING CONDITIONS

ANALOG CHARACTERISTICS

• Min / Max characteristics and specifications are guaranteed over all [Recommended Operating Conditions.](#page-6-1)

• Typical characteristics and specifications are measured at nominal supply voltages and TA = 25 °C .

• VA_+ = VD_+ = 5 V ±5%; AGND = DGND = 0 V; VREFIN = $+2.5$ V. All voltages with respect to 0 V.

 \cdot DCLK = 4.096 MHz.

Notes: 1. Applies when the HPF option is enabled.

2. Applies when the line frequency is equal to the product of the output word rate (OWR) and the value of *Epsilon*.

ANALOG CHARACTERISTICS (Continued)

Notes: 3. Applies before system calibration.

4. All outputs unloaded. All inputs CMOS level.

5. Measurement method for PSRR: VREFIN tied to VREFOUT, $VA_+ = VD_+ = 5 V$, a 150 mV (zero-to-peak) (60 Hz) sinewave is imposed onto the +5 V DC supply voltage at VA+ and VD+ pins. The "+" and "-" input pins of both input channels are shorted to AGND. The CS5464 is then commanded to continuous conversion acquisition mode, and digital output data is collected for the channel under test. The (zero-to-peak) value of the digital sinusoidal output signal is determined, and this value is converted into the (zero-to-peak) value of the sinusoidal voltage (measured in mV) that would need to be applied at the channel's inputs, in order to cause the same digital sinusoidal output. This voltage is then defined as Veq. PSRR is (in dB):

$$
\text{PSRR} = 20 \cdot \log \left[\frac{150}{V_{eq}} \right]
$$

- 6. When voltage level on PFMON is sagging, and LSD bit = 0, the voltage at which LSD is set to 1.
- 7. If the LSD bit has been set to 1 (because PFMON voltage fell below PMLO), this is the voltage level on PFMON at which the LSD bit can be permanently reset back to 0.

VOLTAGE REFERENCE

Notes: 8. The voltage at VREFOUT is measured across the temperature range. From these measurements the following formula is used to calculate the VREFOUT temperature coefficient:.

$$
TC_{VREF} = \left(\frac{(VREFOUT_{MAX} - VREFOUT_{MIN})}{VREFOUT_{AVG}}\right) \left(\frac{1}{T_A_{MAX} - T_A_{MIN}}\right) \left(1.0 \times 10^6\right)
$$

9. Specified at maximum recommended output of 1 µA, source or sink.

DIGITAL CHARACTERISTICS

- Min / Max characteristics and specifications are guaranteed over all [Recommended Operating Conditions.](#page-6-1)
- Typical characteristics and specifications are measured at nominal supply voltages and $TA = 25$ °C.
- $VA_+ = VD_+ = 5V \pm 5\%$; AGND = DGND = 0 V. All voltages with respect to 0 V.
- \cdot DCLK = 4.096 MHz.

Notes: 10. All measurements performed under static conditions.

- 11. If a crystal is used, XIN frequency must remain between 2.5 MHz 5.0 MHz. If an external oscillator is used, XIN frequency range is 2.5 MHz - 20 MHz, but K must be set so that MCLK is between 2.5 MHz - 5.0 MHz.
- 12. If external MCLK is used, the duty cycle must be between 45% and 55% to maintain this specification.
- 13. The frequency of CPUCLK is equal to MCLK.
- 14. The minimum FSCR is limited by the maximum allowed gain register value. The maximum FSCR is limited by the full-scale signal applied to the input.
- 15. Configuration register (*Config*) bits PC[6:0] are set to "0000000".
- 16. The MODE pin is pulled low by an internal resistor.

SWITCHING CHARACTERISTICS

- Min / Max characteristics and specifications are guaranteed over all [Recommended Operating Conditions.](#page-6-1)
- Typical characteristics and specifications are measured at nominal supply voltages and $TA = 25$ °C.
- $VA_+ = 5$ V $\pm 5\%$ VD+ = 3.3 V $\pm 5\%$ or 5 V $\pm 5\%$; AGND = DGND = 0 V. All voltages with respect to 0 V.
- Logic Levels: Logic $0 = 0$ V, Logic $1 = \text{VD} +$.

Notes: 17. Specified using 10% and 90% points on waveform of interest. Output loaded with 50 pF.

18. Oscillator start-up time varies with crystal parameters. This specification does not apply when using an external clock source.

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SWITCHING CHARACTERISTICS (Continued)

Notes: 19. Pulse output timing is specified at DCLK = 4.096 MHz, E2MODE = 0, and E3MODE[1:0] = 0. Refer to 6.7 *[Energy Pulse Outputs](#page-18-7)* on page 19 for more information on pulse output pins.

20. Timing is proportional to the frequency of DCLK.

Figure 2. Timing Diagram for E1, E2, and E3

ABSOLUTE MAXIMUM RATINGS

WARNING: Operation at or beyond these limits may result in permanent damage to the device. Normal operation is not guaranteed at these extremes.

Notes: 21. VA+ and AGND must satisfy $[(VA+) - (AGND)] \le + 6.0$ V.

- 22. VD+ and AGND must satisfy $[(VD+) (AGND)] \le +6.0 V$.
- 23. Applies to all pins including continuous over-voltage conditions at the analog input pins.
- 24. Transient current of up to 100 mA will not cause SCR latch-up.
- 25. Maximum DC input current for a power supply pin is ±50 mA.
- 26. Total power dissipation, including all input currents and output currents.

Figure 3. Signal Flow for V1, I1, P1, Q1 Measurements

4. SIGNAL PATH DESCRIPTION

The data flow for voltage and current measurement and the other calculations are shown in Figures [3,](#page-13-4) [4,](#page-13-5) and [5](#page-15-3).

The data flow consists of two current paths and two voltage paths. Both voltage paths are derived from the same differential input pins. Each current path has its own differential input pins.

4.1 Analog-to-Digital Converters

The voltage and temperature channels use second-order delta-sigma modulators and the two current channels use fourth-order delta-sigma modulators to convert the analog inputs to single-bit digital data streams. The converters sample at a rate of DCLK/8. This high sampling provides a wide dynamic range and simplifies anti-alias filter design.

4.2 Decimation Filters

The single-bit modulator output data is widened to 24 bits and down-sampled to DCLK/1024 with low-pass decimation filters. These decimation filters are third-order Sinc. Their outputs are passed through third-order IIR "anti-sinc" filters, used to compensate for the amplitude roll-off of the decimation filters.

4.3 Phase Compensation

Phase compensation changes the phase of current relative to voltage by changing the sampling time in the decimation filters. The amount of phase shift is set by bits PC[7:0] in the Configuration register (*Config*) for channel 1 and bits PC[7:0] in the Control register (*Ctrl*) for channel 2.

Phase compensation, PC[7:0] is a signed two's complement binary value in the range of -1.0 to almost +1.0 output word rate (OWR) samples. For a sample rate of 4000 Hz, the delay range is $\pm 250 \,\mu S$, a phase shift of ±4.5° at 50 Hz and ±5.4° at 60 Hz. The step size would be 0.0352° at 50 Hz and 0.0422° at 60 Hz at this sample rate.

Figure 4. Signal Flow for V2, I2, P2, Q2 Measurements

4.4 DC Offset and Gain Correction

The system and chip inherently have gain and offset errors which can be removed using the gain and offset registers. (See Section 9. *[System Calibration](#page-38-0)* on page [39](#page-38-0)). Each measurement channel has its own registers. For every channel, the output of the IIR filter is added to the offset register and multiplied by the gain register.

4.5 High-pass Filters

Optional high-pass filters (HPF in Figures [3](#page-13-4) and [4](#page-13-5)) remove any DC from the selected signal paths. Subsequently, DC will also be removed from power, and all low-rate results. (see Figures [5](#page-15-3)).

Each energy channel has a current and voltage path. If an HPF is enabled in only one path, a phase-matching filter (PMF) is applied to the other path which matches the amplitude and phase delay of the HPF in the band

of interest, but passes DC. For more information, see 6.5 *[High-pass Filters](#page-18-5)* on page 19. The HPF filter multiplexers drive the *I1*, *V1*, *I2*, and *V2* result registers.

4.6 Low-Rate Calculations

Low-rate results are derived from sample-rate results integrated over *N* samples, where *N* is the value stored in the Cycle Count register. The low-rate interval is the sample interval multiplied by *N*.

4.7 RMS Results

The root mean square (*RMS* in [Figure 5](#page-15-3)) calculations are performed on *N* instantaneous voltage and current samples, using the formula:

$$
I_{RMS} = \sqrt{\frac{\sum_{n=0}^{N-1} I_n^2}{N}}
$$

Figure 5. Low-rate Calculations

4.8 Power and Energy Results

The instantaneous voltage and current samples are multiplied to obtain the instantaneous power (*P1*, *P2*) (see [Figure 3](#page-13-4) and [4](#page-13-5)). The product is then averaged over *N* conversions to compute active power (*P1AVG*, *P2AVG*).

Apparent power (*S1*, *S2*) is the product of RMS voltage and current as shown:

$$
S = V_{RMS} \times I_{RMS}
$$

Power factor (*PF1*, *PF2*) is active power divided by apparent power as shown below. The sign of the power factor is determined by the active power.

$$
PF = \frac{P_{ACTIVE}}{S}
$$

Wideband reactive power (*Q1WB*, *Q2WB*) is calculated by doing a vector subtraction of active power from apparent power.

$$
Q_{WB} = \sqrt{S^2 - P_{ACTIVE}^2}
$$

Quadrature power (*Q1*, *Q2*) are sample rate results obtained by multiplying instantaneous current (*I1*, *I2*) by instantaneous quadrature voltage (*V1Q*, *V2Q*) which are created by phase shifting instantaneous voltage (*V1*, *V2*) 90 degrees using first-order integrators. (see [Figure](#page-13-4) [3](#page-13-4) and [4\)](#page-13-5). The gain of these integrators is inversely related to line frequency, so their gain is corrected by the *Epsilon* register, which is based on line frequency.

Reactive power (*Q1AVG*, *Q2AVG*) is generated by integrating the instantaneous quadrature power over *N* samples.

4.9 Peak Voltage and Current

Peak current (*I1PEAK*, *I2PEAK*) and peak voltage (*V1PEAK*, *V2PEAK*) are the largest current and voltage samples detected in the previous low-rate interval.

4.10 Power Offset

The power offset registers, *P1OFF* (*P2OFF*) can be used to offset erroneous power sources resident in the system not originating from the power line. Residual power offsets are usually caused by crosstalk into current paths from voltage paths or from ripple on the meter or chip's power supply, or from inductance from a nearby transformer.

These offsets can be either positive or negative, indicating crosstalk coupling either in phase or out of phase with the applied voltage input. The power offset registers can compensate for either condition.

To use this feature, measure the average power at no load using either Single or Continuous Conversion commands. Take the measured result (from the *P1AVG* (*P2AVG*) register), invert (negate) the value and write it to the associated power offset register, *P1OFF* (*P2OFF*).

5. PIN DESCRIPTIONS

5.1 Analog Pins

The CS5464 has three differential inputs: VIN_{\pm} , IIN1 $_{\pm}$, and $IIN2_±$ are the voltage, current1, and current2 inputs, respectively. A single-ended power fail monitor input, voltage reference input, and voltage reference output are also available.

5.1.1 Voltage Inputs

The output of the line voltage resistive divider or transformer is connected to the VIN+ and VIN- input pins of the CS5464. The voltage channel is equipped with a 10x, fixed-gain amplifier. The full-scale signal level that can be applied to the voltage channel is ±250mV. If the input signal is a sine wave, the maximum RMS voltage is 250 mVp / $\sqrt{2} \approx 176.78$ mVRMS which is approximately 70.7% of maximum peak voltage.

5.1.2 Current1 and Current2 Inputs

The output of the current-sensing resistor or transformer is connected to the IIN1+ (IIN2+) and IIN1- (IIN2-) input pins of the CS5464. To accommodate different current-sensing elements, the current channel incorporates a programmable gain amplifier (PGA) with two selectable input gains. The full-scale signal level for the current channels is ±50mV or ±250mV. If the input signal is a sine wave, the maximum RMS voltage is 35.35mVRMS or 176.78mVRMS which is approximately 70.7% of maximum peak voltage.

5.1.3 Power Fail Monitor Input

An analog input (PFMON) is provided to determine when a power loss is imminent. By connecting a resistive divider from the unregulated meter power supply to the PFMON input, an interrupt can be generated, or the Low Supply Detected (LSD) *Status* register bit can be monitored to indicate low-supply conditions. The PF-MON input has a comparator that trips around the level of the voltage reference input (VREFIN).

5.1.4 Voltage Reference Input

The CS5464 requires a stable voltage reference of 2.5 V applied to the VREFIN pin. This reference can be supplied from an external voltage reference or from the VREFOUT output. A bypass capacitor of at least $0.1 \mu F$ is recommended at the VREFIN pin.

5.1.5 Voltage Reference Output

The CS5464 generates a 2.5 V reference (VREFOUT). It is suitable for driving the VREFIN pin, but has very little fan-out and is not recommended for driving external circuits.

5.1.6 Crystal Oscillator

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An external quartz crystal can be connected to the XIN and XOUT pins as shown in Figure [6](#page-16-13). To reduce system cost, each pin is supplied with an on-chip, phase-shifting capacitor to ground.

Figure 6. Oscillator Connections

Alternatively, an external clock source can be connected to the XIN pin.

5.2 Digital Pins

5.2.1 Reset Input

The active-low RESET pin, when asserted, will halt all CS5464 operations and reset internal hardware registers and states. When de-asserted, an initialization sequence begins, setting default register values.

5.2.2 CPU Clock Output

A logic-level clock output (CPUCLK) is provided at the crystal frequency to drive an external CPU or microcontroller clock. Two phase choices are available.

5.2.3 Interrupt Output

The INT pin indicates an enabled Internal Status register (*Status*) bit is set. *Status* register bits indicate conditions such as data ready, modulator oscillations, low supply, voltage sag, current faults, numerical overflows, and result updates.

5.2.4 Energy Pulse Outputs

The CS5464 provides three pins (E1, E2, E3) for pulse energy outputs. These pins can also be used to output other conditions, such as voltage sign, power fail monitor, or energy channel in use.

5.2.5 Serial Interface

The CS5464 provides 5 pins, SCLK, SDI, SDO, CS, and MODE for communication between a host microcontroller or serial E^2 PROM and the CS5464.

MODE is an input that, when high, indicates to the CS5464 that a serial E^2 PROM is being used instead of a host microcontroller. It has a weak pull-down allowing it to be left unconnected if microcontroller mode is used.

SCLK is used to shift and qualify serial data. Serial data changes as a result of the falling edge of SCLK and is valid during the rising edge. It is a Schmitt-trigger input for host microcontrollers, and a driven output for serial E²PROMs.

SDI is the serial data input to the CS5464.

SDO is the serial data output from the CS5464. It's output drivers are disabled whenever $\overline{\text{CS}}$ is de-asserted, allowing other devices to drive the SDO line.

CS is the chip select input for the serial bus. A high logic level de-asserts it, tri-stating the SDO pin and clearing the serial interface. A low logic level enables the serial port. This pin may be tied low for systems not requiring multiple SDO drivers. $\overline{\text{CS}}$ is a driven output when interfacing to serial E^2 PROMs.

6. SETTING UP THE CS5464

6.1 Clock Divider

The internal clock to the CS5464 needs to operate around 4 MHz. However, by using the internal clock divider, a higher crystal frequency can be used. This is important when driving an external microcontroller requiring a faster clock and using the CPUCLK output.

K is the divide ratio from the crystal input to the internal clock and is selected with Configuration register (*Config*) bits K[3:0]. It has a range of 1 to 16. A value of zero results in a setting of 16.

6.2 CPU Clock Inversion

By default, CPUCLK is inverted from XIN. Setting Configuration register bit iCPU removes this inversion. This can be useful when one phase adds more noise to the system than the other.

6.3 Interrupt Pin Behavior

The behavior of the $\overline{\text{INT}}$ pin is controlled by the IMODE and IINV bits in the Configuration register as shown.

Table 1. Interrupt Configuration

If IMODE = 1, the duration of the $\overline{\text{INT}}$ pulse will be two DCLK cycles, where DCLK = MCLK/K.

6.4 Current Input Gain Ranges

Control register bits I1gain (I2gain) select the input range of the current inputs.

I1gain, I2gain	Maximum Input	Gain		
	$±250$ mV	10x		
	$±50$ mV	50x		

Table 2. Current Input Gain Ranges

6.5 High-pass Filters

Mode Control (*Modes*) register bits VHPF and IHPF activate the HPF in the voltage and current paths, respectively. Each energy channel has separate VHPF and IHPF bits. When a high-pass filter is enabled in only one

path within a channel, a phase matching filter (PMF) is applied to the other path within that channel. The PMF filter matches the amplitude and phase response of the HPF in the band of interest, but passes DC.

6.6 Cycle Count

Low-rate calculations, such as average power and RMS voltage and current integrate over several (*N*) output word rate (OWR) samples. The duration of this averaging window is set by the Cycle Count (*N*) register. By default, Cycle Count is set to 4000 (1 second at output word rate [OWR] of 4000 Hz). The minimum value for Cycle Count is 10.

6.7 Energy Pulse Outputs

By default, E1 outputs active energy, E3, reactive energy, and E2, the sign of both active and reactive energy. (See Figure 2. *[Timing Diagram for E1, E2, and E3](#page-12-2)* on [page 13](#page-12-2).)

Three pairs of bits in the Mode Control (*Modes*) register control the operation of these outputs. These bits are named E1MODE[1:0], E2MODE[1:0], and E3MODE[1:0]. Some combinations of these bits override others, so read the following paragraphs carefully.

The E2 pin can output energy sign, apparent energy, or energy channel in use (1 or 2). [Table 4](#page-18-11) lists the functions of E2 as controlled by E2MODE[1:0] in the *Modes* register*.*

Note: E2MODE[1:0]=3 is a special mode.

Table 4. E2 Pin Configuration

The E3 pin can output reactive energy, power fail monitor status, voltage sign, or apparent energy. [Table 5](#page-19-4) **IRRUS LOGIC**

lists the functions of E3 as controlled by E3MODE[1:0] in the *Modes* register when E1MODE is not enabled.

E3MODE1	E3MODE0	E3 output
		Reactive Energy
		Power Fail Monitor
		Voltage Sign
		Apparent Energy

Table 5. E3 Pin Configuration

When both E2MODE bits are high, the E1MODE bits are enabled, allowing active, apparent, reactive, or wideband reactive energy for *both* energy channels to be output on E1 and E2. [Table 6](#page-19-5) lists the functions of E1 and E2 with E1MODE enabled.

E1MODE1	E1MODE0	E1 / E2 outputs
		Active Energy
		Apparent Energy
		Reactive Energy
		Wideband Reactive

Table 6. E1 / E2 Modes

When E1MODE bits are enabled, the E3 pin outputs either the power fail monitor status, or the sign of the E1 and E2 outputs. [Table 7](#page-19-6) list the functions of the E3 pin using E3MODE[1:0] in the *Modes* register when E1MODE is enabled *.*

6.8 No Load Threshold

The No Load Threshold register (*LoadMIN*) is used to zero out the contents of *EPULSE* and *QPULSE* registers if their magnitude is less than the *LoadMIN* register value.

6.9 Energy Pulse Width

Note: Energy Pulse Width (*PulseWidth*) only applies to E1, E2, or E3 pins that are configured to output pulses. When any are configured to output steady-state signals, such as voltage sign, energy channel in use, power fail monitor, or energy sign, pulse widths and output rates do not apply.

The pulse width time (t_{ow}) in [Figure 2](#page-12-2), is set by the value in the *PulseWidth* register which is an integer multiple of the sample or output word rate (OWR). At OWR of 4000 Hz (a period of 250 uS) t_{pw} = *PulseWidth* x 250uS. By default, *PulseWidth* is set to 1.

6.10 Energy Pulse Rate

The full-scale pulse frequency of enabled E1, E2, E3 pins is the *PulseRate* x output word rate (OWR)/2. The actual pulse frequency is the full-scale pulse frequency multiplied by the pulse register's (*EPULSE*, *SPULSE*, *QPULSE*) value.

Example:

If the output word rate (OWR) is 4000 Hz, and the *PulseRate* is set to 0.05, the full-rate pulse frequency is $0.05 \times 4000 / 2 = 100$ Hz. If the E_{PULSE} register, driving E1, is 0.4567, the pulse output rate on E1 will be 100 Hz x 0.4567 = 45.67 Hz.

6.11 Voltage Sag/Current Fault Detection

Voltage sag detection is used to determine when averaged voltage falls below a predetermined level for a specified interval of time. Current fault detection determines when averaged current falls below a predetermined level for a specified interval of time.

The specified interval of time (duration) is set by the value in the *V1SagDUR* (*V2SagDUR*) and *I1FaultDUR* (*I2FaultDUR*) registers. Setting any of these to zero (default) disables the detect feature for the given channel. The value is in output word rate (OWR) samples. The predetermined level is set by the values in the *V1SagLEVEL* (*V2SagLEVEL*) and *I1FaultLEVEL* (*I2Fault_{I FVFI}*) registers.

Since the values of *V1* and *V2* come from the same input, only one voltage sag detector is necessary.

For each enabled input channel, the measured value is rectified and compared to the associated level register*.* Over the duration window, the number of samples above and below the level are counted. If the number of samples below the level exceeds the number of samples above, a *Status* register bit V1_{SAG} (V2_{SAG}), I1_{FAULT} (I2_{FAULT}) is set, indicating a sag or fault condition. (see [Figure 7\)](#page-20-2)..

Figure 7. Sag and Fault Detect

6.12 Epsilon

The *Epsilon* register is used to set the gain of the 90° phase shift used in the quadrature power calculation.

The value in the *Epsilon* register is the ratio of the line frequency to the output word rate (OWR). It is, by default, 50/4000 (0.0125), for 50 Hz line and 4000 Hz sample (OWR) frequencies.

For 60 Hz line frequency, it is 60/4000 (0.015). Other output word rates (OWR) can be used.

Epsilon can also be calculated automatically by the CS5464 by setting the AFC bit in the Mode Control (*Modes*) register. The Frequency Update bit (FUP) in the *Status* register is set every time the *Epsilon* register has been automatically updated.

6.13 Temperature Measurement

The on-chip temperature sensor is designed to measure temperature and optionally compensate for temperature drift of the voltage reference. It uses the VBE of a transistor to determine temperature.

Temperature measurements are stored in the Temperature register (*T*) which, by default, is configured to a range of ±128 degrees on the Celsius (°C) scale.

The application program can change both the scale and range of Temperature (*T*) by changing the Temperature Gain (*TGAIN*) and Temperature Offset (*TOFF*) registers.

Two values must be known $-$ the transistor's Δ VBE per degree, and the transistor's VBE at 0 degrees. At the time of this publication, these values are:

 \triangle VBE (per degree) = 0.2769523 mV/ \degree C or \degree K

 V_{BE} 0 = 79.2604368 mV at 0°C

To determine the values to write to T_{GAM} and T_{OFE} , use the following formulae:

$$
T_{GAIN} = AD_{FS} / \Delta VBE / T_{FS} \times 2^{17}
$$

$$
T_{OFF} = -V_{BE} \times 2^{17} \times 2^{23}
$$

In the above equations, AD_{FS} is the full-scale input range of the temperature A/D converter or 833.333 mV and T_{FS} is the desired full-scale range of the Temperature register. The binary exponents are the bit positions of the binary point of these registers.

To use the Celsius scale (°C) and cover the chip's operating temperature range of -40°C to +85°C, the Temperature register range needs to be ± 128 degrees. T_{FS} should be 128 degrees.

TGAIN = 833.333 / 0.2769523 / 128 x 131072 $= 3081155 (0x2F03C3)$ *TOFF* = -79.2604368 / 833.333 x 8388608

= -797862 (0xF3D35A)

These are the actual default values for these registers.

 T_{GAIN} and T_{OFF} can also be used to calibrate the gain and/or offset of the temperature sensor or A/D converter. (See Section 9. *[System Calibration](#page-38-0)* on page 39).

To use the Kelvin (°K) scale, simply add 273 times \triangle VBE / AD_{FS} x 2²³ to T_{OFF} since 0°C = 273°K,. You will also need more range. Since -40°C to +85°C is 233°K to 358°K, a T_{FS} of 512 degrees should be used in the *TGAIN* calculation.

To use the Fahrenheit (${}^{\circ}$ F) scale, multiply Δ VBE by 5/9 and add 32 times the new Δ VBE / AD_{FS} x 2²³ to T_{OFF} since 0°C = 32°F. You will also want to use a T_{FS} of 256 degrees to cover the -40°C to +85°C range.

The Temperature register (*T*) updates every 2240 output word rate (OWR) samples. The *Status* register bit TUP indicates when *T* is updated.

7. USING THE CS5464

7.1 Initialization

The CS5464 uses a power-on-reset circuit (POR) to provide an internal reset until the analog voltage reaches 4.0 V. The RESET input pin can also be used by the application circuit to reset the part.

After RESET is removed and the oscillator is stable, an initialization program is executed to set the default register values.

A Software Reset command is also provided to allow the application to run the initialization program without removing power or asserting RESET.

The application should avoid sending commands during initialization. The DRDY bit in the *Status* register indicates when the initialization program has completed.

7.2 Power-down States

The CS5464 has two power-down states, stand-by and sleep. In the stand-by state, all circuitry except the voltage reference and crystal oscillator is powered off. In sleep state, all circuitry except the instruction decoder is powered off.

To return the device to the active state, send a Wake-Up/Halt command to the device. When returning from stand-by mode, registers will retain their contents prior to entering the stand-by state. When returning from sleep mode, a complete initialization occurs.

7.3 Tamper Detection and Correction

The CS5464 provides compensation for at least two forms of meter tampering. A second current input is provided in the event that the primary input is impaired by tampering. (See [Figure 14 on page 42\)](#page-41-0). An internal RMS voltage reference is also available in the event that the voltage input has been compromised by tampering.

Power and energy are calculated for BOTH current inputs (both energy channels). The CS5464 can automatically choose the channel with the greater magnitude. The register *EMIN*, (also called *IrmsMIN*) sets a minimum level for automatic channel selection, and *Ichan_{I FVFI}* sets a minimum difference that will allow a channel

change. *Modes* register bit Ichan selects the energy channel, and is normally driven by the CS5464 program. This affects the pulse registers and pulse energy outputs. (See figure [8](#page-21-4)).

The application program can also choose the more appropriate energy channel. *Modes* register bit Ihold disables automatic selection and Ichan can be driven by the application. Shown below is the channel selector.

Figure 8. Energy Channel Selection

If the application detects that the voltage input has been impaired it may choose to use the fixed internal RMS voltage reference by setting the VFIX bit in the *Modes* register. The value of this reference (*VFRMS*) is by default 0.707107 (full-scale RMS) but can be changed by the application program. (See figure [9\)](#page-21-5)

Figure 9. Fixed RMS Voltage Selection

7.4 Command Interface

Commands and data are transferred most-significant bit (MSB) first. [Figure 1 on page 12](#page-11-0), defines the serial port timing. Commands are clocked in on SDI using SCLK. They are a single byte (8 bits) long and fall into one of four basic types:

- 1. Register Read
- 2. Register Write
- 3. Synchronizing
- 4. Instructions

Register reads will cause up to four bytes of register data to be clocked out, MSB first on the SDO pin by SCLK. During this time, other commands can be clocked in on the SDI pin. Other commands will not interrupt read data, except another register read, which will cause the new read data to appear on SDO.

Synchronizing can be sent while read data is being clocked out if no other commands need to be sent.

Synchronizing commands are also used to synchronize the serial port to a byte boundary. The \overline{CS} and $\overline{\text{RESET}}$ pins will also synchronize the serial port.

Register writes require three bytes of write data to follow, clocked in on the SDI pin, MSB first by SCLK.

Instructions are commands that will interrupt any instruction currently executing and begin the new instruction. These include conversions, calibrations, power control, and soft reset.

([See Section 7.6](#page-23-0) *Commands* on page 24).

7.5 Register Paging

Read and Write commands access one of 32 registers within a specified page. The Resgister Page Select register's (*Page*) default value is 0. To access registers in another page, write the desired page number to the *Page* register. The *Page* register is always at address 31 and is accessible from within any page.

7.6 Commands

All commands are 1 byte (8 bits) long. Many command values are unused and should NOT be written by the application program. All commands except register reads, register writes, or synchronizing commands will abort any conversion, calibration, or any initialization sequence currently executing. This includes reset. No commands other than reads or synchronizing should be executed until the reset sequence completes.

7.6.1 Conversion

Executes a conversion (measurement) program.

CC Continuous/Single Conversion 0 = Perform a Single Conversion (0xE0) 1 = Perform Continuous Conversion (0xE8)

7.6.2 Synchronization (SYNC0 and SYNC1)

The serial interface is bidirectional. While reading data on the SDO output, the SDI input must be receiving commands. If no command is needed during a read, SYNC0 or SYNC1 commands can be sent while read data is received on SDO.

The serial port is normally initialized by de-asserting \overline{CS} . An alternative method of initialization is to send 3 or more SYNC1 commands followed by a SYNC0. This is useful in systems where CS is not used and tied low.

7.6.3 Power Control (Stand-by, Sleep, Wake-up/Halt and Software Reset)

The CS5464 has two power-down states, stand-by and sleep. In stand-by, all circuitry except the voltage reference and clocks are turned off. In sleep, all circuitry except the command decoder is turned off. A Wake-up/Halt command restores full-power operation after stand-by and issues a hardware reset after sleep. The Software Reset command is a program that emulates a pin reset and is not a power control function.

S[1:0] 00 = Software Reset

- $01 = Sleep$
- $10 = \text{Wake-up/Half}$
- $11 =$ Stand-by

7.6.4 Calibration

The CS5464 can perform gain and offset calibrations using either DC or AC signals. Proper input levels must be applied to the current inputs and voltage input before performing calibrations.

7.6.5 Register Read and Write

Read and Write commands provide access to on-chip registers. After a Read command, the addressed data can be clocked out the SDO pin by SCLK. After a Write command, 24 bits of write data must follow. The data is transferred to the addressed register after the 24th data bit is received. Registers are organized into pages of 32 addresses each. To access a desired page, write its number to the *Page* register at address 31.

W/R Write/Read control

 $0 = Read$

 $1 = Write$

RA[4:0] Register address.

Page 0 Registers

Warning: *Do not* write to unpublished register locations.

Page1 Registers

Page2 Registers

Warning: *Do not* write to unpublished register locations.

8. REGISTER DESCRIPTIONS

- 1. "Default" = bit states after power-on or reset
- 2. DO NOT write a "1" to any unpublished register bit.
- 3. DO NOT write to any unpublished register address.

8.1 Page Register

8.1.1 Page – Address: 31, Write-only, can be written from ANY page.

Default $= 0$

Register Read and Write commands contain only 5 address bits. But the internal address bus of the CS5464 is 12 bits wide. Therefore, registers are organized into "Pages". There are 128 pages of 32 registers each. The *Page* register provides the 7 high-order address bits and selects one of the 128 register pages. Not all pages are used,

Page is a write-only integer containing 7 bits.

8.2 Page 0 Registers

8.2.1 Configuration (Config) – *Address: 0*

Default = 1 (K=1)

8.2.2 Instantaneous Current (I1, I2), Voltage (V1, V2), and Power (P1, P2) Address: 1 (*I1*), 2 (*V1*), 3 (*P2*), 7 (*I2*), 8 (*V2*), 9 (*P2*)

I1 (*I2*) and *V1* (*V2*) contain instantaneous current and voltage, respectively, which are multiplied to yield instantaneous power, $P1 (P2)$. These are two's complement values in the range of -1.0 \leq value $<$ 1.0, with the binary point to the right of the MSB.

8.2.3 Active Power (P1AVG , P2AVG) Address: 4 (*P1AVG*), 10 (*P2AVG*)

Instantaneous power is averaged over each low-rate interval (*N* samples) to compute active power, *P1AVG* $(P2_{AVG})$. These are two's complement values in the range of -1.0 \leq value $<$ 1.0, with the binary point to the right of the MSB.

^{8.2.4} RMS Current (I1RMS, I2RMS) and Voltage (V1RMS, V2RMS) Address: 5 (*I1RMS*), 6 (*V1RMS*), 11 (*I2RMS*), 12 (*V2RMS*)

MSB														LSB
\sim -	\sim <u>_</u> -	_ი-პ -	\sim -4 	- n-5 -	\sim ი-ხ -	- \sim - -	ഹ-്	 $n - 18$ --	$n - 19$ -	Ω າ∹∠∪	\sim י ∠-ה -	ററ ∠∠-∩ -	Ω ი-∠ა -	$n - 24$ -

I1RMS (*I2RMS*) and *V1RMS* (*V2RMS*) contain the root mean square (RMS) values of *I1* (*I2*) and *V1* (*V2*), calculated each low-rate interval. These are unsigned values in the range of $0 \le$ value < 1.0 , with the binary point to the left of the MSB.

^{8.2.5} Instantaneous Quadrature Power (Q1, Q2) Address: 14 (*Q1*), 17 (*Q2*)

MSB														LSB
י0מי └	\sim -	n-2 <u>_</u> -	ϵ ი-ა	∩-4 -	- _ი-ხ -	\sim n-b -	- \sim -	 \rightarrow n- -	10 ~- -	$n - 19$ -	$20 - 20$ -	\sim \sim <u>_</u> -	$n - 22$ -	\sim റ-∠ം -

Instantaneous quadrature power, *Q1* (*Q2*), the product of voltage1 (voltage2) shifted 90 degrees and current1 (current2). These are two's complement values in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB.

8.2.6 Reactive Power (Q1AVG, Q2AVG) Address: 13 (*Q1AVG*), 16 (*Q2AVG*)

Reactive power *Q1AVG* (*Q2AVG*) is *Q1* (*Q2*) averaged over every *N* samples. These are two's complement values in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB.

8.2.7 Peak Current (I1PEAK, I2PEAK) and Peak Voltage (V1PEAK, V2PEAK)

Address: 18 (*I1PEAK*), 19 (*V1PEAK*), 22 (*I2PEAK*), 23 (*V2PEAK*)

Peak current, *I1PEAK* (*I2PEAK*) and peak voltage, *V1PEAK* (*V2PEAK*) are the instantaneous current and voltage samples with the greatest magnitude detected during the last low-rate interval. These are two's complement values in the range of $-1.0 \leq$ value < 1.0 , with the binary point to the right of the MSB.

8.2.8 Apparent Power (S1, S2)

Address: 20 (S1), 24 (S2)

Apparent power *S1* (*S2*) is the product of *V1RMS* and *I1RMS* (*V2RMS* and *I2RMS*), These are two's complement values in the range of $0 \leq$ value < 1.0 , with the binary point to the right of the MSB.

8.2.9 Power Factor (PF1, PF2)

Address: 21 (*PF1*), 25 (*PF2*)

Power factor is calculated by dividing active power by apparent power. The sign is determined by the active power sign. These are two's complement values in the range of $-1.0 \le v$ alue < 1.0 , with the binary point to the right of the MSB.

8.2.10 Temperature (T) – *Address: 27*

T contains results from the on-chip temperature measurement. By default, *T* uses the Celsius scale, and is a two's complement value in the range of -128.0 \le value $<$ 128.0 (°C), with the binary point to the right of bit 16. *T* can be rescaled by the application using the *TGAIN* and *TOFF* registers.

8.2.11 Active, Apparent, and Reactive Energy Pulse Outputs (EPULSE, SPULSE, QPULSE) Address: 29 *(EPULSE),* 30 *(SPULSE),* 31 *(QPULSE)*

These drive the pulse outputs when configured to do so. If the Ichan bit in *Modes* is "0", these registers are driven from *P1AVG*, *S1*, and *Q1AVG*, respectively. If the Ichan bit is "1", these registers are driven from *P2AVG*, *S2*, and $Q2_{AVG}$, respectively. These are two's complement values in the range of -1.0 \leq value $<$ 1.0, with the binary point to the right of the MSB.

8.2.12 Internal Status (Status) and Interrupt Mask (Mask) Address: 15 (*Status*); 26 (*Mask*)

Default = 1 (*Status*), 0 (*Mask*)

The *Status* register indicates a variety of conditions within the chip. Writing a '1' to a *Status* register bit will clear that bit if the condition that set it has been removed. Writing a '0' to any bit has no effect.

The *Mask* register is used to control the activation of the INT pin. Placing a logic '1' to a *Mask* register bit will allow the corresponding *Status* register bit to activate the INT pin when set.

8.2.13 Control (Ctrl) – *Address: 28*

Default $= 0$

8.3 Page 1 Registers

8.3.1 DC Offset for Current (I1OFF , I2OFF) and Voltage (V1OFF , V2OFF) Address: 0 (*I1OFF*), 2 (*V1OFF*), 7 (*I2OFF*), 9 (*V2OFF*)

Default $= 0$

DC offset registers *I1OFF* & *V1OFF* (*I2OFF* & *V2OFF*) are initialized to zero on reset. During DC offset calibration, selected registers are written with the inverse of the DC offset measured. The application program can also write the DC offset register values. These are two's complement values in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB.

8.3.2 Gain for Current (I1GAIN , I2GAIN) and Voltage (V1GAIN , V2GAIN) Address: 1 (*I1GAIN*), 3 (*V1GAIN*), 8 (*I2GAIN*), 10 (*V2GAIN*)

Default $= 1.0$

Gain registers *I1GAIN* & *V1GAIN* (*I2GAIN* & *V2GAIN*) are initialized to 1.0 on reset. During AC or DC gain calibration, selected register are written with the multiplicative inverse of the gain measured. These are unsigned fixed-point values in the range of $0 \leq$ value $<$ 4.0, with the binary point to the right of the second MSB.

8.3.3 Power Offset (P1OFF , P2OFF)

Address: 4 (*P1OFF*), 11 (*P2OFF*)

Default $= 0$

Power offset *P1OFF* (*P2OFF*) is added to instantaneous power and averaged over a low-rate interval to yield *P1AVG* (*P2AVG*) register results. It can be used to reduce systematic energy errors. These are two's complement values in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB.

8.3.4 AC Offset for Current (I1ACOFF , I2ACOFF) and Voltage (V1ACOFF , V2ACOFF) Address: 5 (*I1ACOFF*), 6 (*V1ACOFF*), 12 (*I2ACOFF*), 13 (*V2ACOFF*)

Default $= 0$

AC offset registers *I1ACOFF* & *V1ACOFF* (*VACOFF* & *V2ACOFF*) are initialized to zero on reset. These are added to the RMS results before being stored to the RMS result registers. They can be used to reduce systematic errors in the RMS results. These are two's complement values in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB.

8.3.5 Mode Control (Modes) – *Address: 16*

IRRUS LOGIC®

E3MODE[1:0] E3 Output Mode **(with E1MODE enabled)**

- 00 = Power Fail Monitor
- 01 = Energy Sign
- $10 = not used$
- $11 = not used$
- POS Positive Energy Only. Suppresses negative values in *P1AVG* and *P2AVG*. If a negative value is calculated, zero will be stored instead.
- AFC Enables automatic line frequency measurement which sets *Epsilon* every time a new line frequency measurement completes. *Epsilon* is used to control the gain of the 90 degree phase shift integrator used in quadrature power calculations.
- 8.3.6 Line to Sample Frequency Ratio (Epsilon) Address: 17

Default = 0.0125 (4.0 kHz x 0.0125 or 50 Hz)

Epsilon is the ratio of the input line frequency to the output word rate (OWR). It can either be written by the application program or calculated automatically from the line frequency (from the voltage input) using the AFC bit in the *Modes* register. It is a two's complement value in the range of $-1.0 \le$ value < 1.0 , with the binary point to the right of the MSB. Negative values are not used.

8.3.7 Pulse Output Width (PulseWidth) – *Address: 14*

Default = 1 (250 uS at OWR = 4 kHz)

PulseWidth sets the duration of energy pulses. The actual pulse duration is the contents of *PulseWidth* divided by the output word rate (OWR). *PulseWidth* is an integer in the range of 1 to 8,388,607.

8.3.8 Pulse Output Rate (PulseRate) – *Address: 15*

Default= -1

PulseRate sets the full-scale frequency for $\overline{E1}$, $\overline{E2}$, $\overline{E3}$ pulse outputs. For a 4 kHz sample rate, the maximum pulse rate is 2 kHz. This is a two's complement value in the range of $-1 \le$ value < 1 , with the binary point to the left of the MSB.

Refer to 6.10 *[Energy Pulse Rate](#page-19-2)* on page 20 for more information.

8.3.9 Cycle Count (N) – *Address: 19*

Default $= 4000$

Determines the number of output word rate (OWR) samples to use in calculating low-rate results. Cycle Count (*N*) is an integer in the range of 10 to 8,388,607. Values less than 10 should not be used.

8.3.10 Channel Select Level (Ichanlevel) – *Address: 18*

Default = 1.02 (minimum difference = $2\%)$

Sets the hysteresis level for energy channel selection. If the most positive value of *P1AVG* and *P2AVG* (*I1RMS* and *I2RMS*) is greater than *IchanLEVEL* multiplied by the least-positive value, and is also greater than *IchanMIN*, the channel associated with the most-positive value will be used. If not, the previous channel selection will remain. *Ichan*_{LEVEL} is an unsigned fixed-point value in the range of $0 \le$ value < 2.0 , with the binary point to the left of the MSB. A value of 1.0 or less indicates no hysteresis will be used.

8.3.11 Channel Select Minimum Amplitude (EMIN or IrmsMIN) – *Address: 24*

Default $= 0.003$

Sets the minimum level for energy channel selection. If the most positive value of *P1AVG* and *P2AVG* (*I1RMS* and *I2RMS*) is less than *IchanMIN* then the previous channel selection will remain in use. It is a two's complement value in the range of -1.0 \leq value $<$ 1.0, with the binary point to the right of the MSB. Negative values are not used.

8.3.12 Wideband Reactive Power (Q1WB , Q2WB)

Address: 20 (*Q1WB*), 21 (*Q2WB*)

Wideband reactive power is calculated using vector subtraction. (See Section 4.8 *[Power and Energy Results](#page-15-0)* [on page 16\)](#page-15-0). The value is signed, but has a range of $0 \le$ value $<$ 1.0. The binary point is to the right of the MSB.

8.3.13 Temperature Gain (TGAIN) – *Address: 22*

 $Default = 0x2F02C3$

Refer to 6.13 *[Temperature Measurement](#page-20-1)* on page 21 for more information.

8.3.14 Temperature Offset (TOFF) – *Address: 23*

Default = 0xF3D35A

Refer to 6.13 *[Temperature Measurement](#page-20-1)* on page 21 for more information.

8.3.15 Filter Settling Time for Conversion Startup (TSETTLE) – *Address: 25*

Default $= 30$

Sets the number of output word rate (OWR) samples that will be used to allow filters to settle at the beginning of Conversion and Calibration commands. This is an integer in the range of 0 to 8,388,607 samples.

8.3.16 No Load Threshold (LoadMIN) – *Address 26*

Default $= 0$

LoadMIN is used to set the no load threshold. When the magnitude of the *EPULSE* register is less than *LoadMIN*, *EPULSE* will be zeroed. If the magnitude of the *QPULSE* register is less than *LoadMIN*, *Qpulse* will be zeroed. Load_{MIN} is a two's compliment value in the range of -1.0 \le value $<$ 1.0, with the binary point to the right of the MSB. Negative values are not used.

8.3.17 Voltage Fixed RMS Reference (VFRMS) – *Address 27*

Default = 0.7071068 (full scale RMS)

If the application program detects that the meter has possibly been tampered with in such a manner that the voltage input is no longer working, it may choose to use this internal RMS reference instead of the disabled voltage input by setting the VFIX bit in the *Modes* register. This is a two's complement value in the range of $0 \leq$ value $<$ 1.0, with the binary point to the right of the MSB. Negative values are not used.

8.3.18 System Gain (G) – *Address: 28*

Default $= 1.25$

System Gain (*G*) is applied to all channels. By default, *G* = 1.25, but can be finely adjusted to compensate for voltage reference error. It is a two's complement value in the range of -2.0 \leq value $<$ 2.0, with the binary point to the right of the second MSB. Values should be kept within 5% of 1.25.

8.3.19 System Time (Time) – *Address: 29*

Default $= 0$

System Time (*Time*) is measured in output word rate (OWR) samples. This is an unsigned integer in the range of 0 to 16,777,215 samples. At 4.0 kHz, OWR it will overflow every 1 hour, 9 minutes, and 54 seconds. *Time* can be used by the application to manage real-time events.

8.4 Page 2 Registers

8.4.1 Voltage Sag and Current Fault Duration (V1SagDUR , V2SagDUR , I1FaultDUR , I2FaultDUR) Address: 0 (*V1SagDUR*), 8 (*V2SagDUR*), 4 (*I1FaultDUR*), 12 (*I2FaultDUR*)

Default $= 0$

Voltage sag duration, *V1SagDUR* (*V2SagDUR*) and current fault duration, *I1FaultDUR* (*I2FaultDUR*) determine the count of output word rate (OWR) samples utilized to determine a sag or fault event. These are integers in the range of 0 to 8,388,607 samples. A value of zero disables the feature.

8.4.2 Voltage Sag and Current Fault Level (V1SagLEVEL , V2SagLEVEL , I1FaultLEVEL , I2FaultLEVEL) Address: 1 (*V1SagLEVEL*), 9 (*V2SagLEVEL*), 5 (*I1FaultLEVEL*), 13 (*I2FaultLEVEL*)

Default $= 0$

Voltage sag level, *V1SagLEVEL* (*V2SagLEVEL*) and current fault level, *I1FaultLEVEL* (*I2FaultLEVEL*) establish an input level below which a sag or fault is triggered These are two's complement values in the range of $-1.0 \leq$ value < 1.0 , with the binary point to the right of the MSB. Negative values are not used.

9. SYSTEM CALIBRATION

9.1 Calibration

The CS5464 provides DC offset and gain calibration that can be applied to the voltage and current measurements, and AC offset calibration which can be applied to the voltage and current RMS calculations.

Since the voltage and current channels have independent offset and gain registers, offset and gain calibration can be performed on any channel independently.

The data flow of the calibration is shown in [Figure 10](#page-38-5).

The CS5464 must be operating in its active state and ready to accept valid commands. Refer to 7.6 *[Com](#page-23-0)mands* [on page 24.](#page-23-0)

The value in the Cycle Count register (*N*) determines the number of output word rate (OWR) samples that are averaged during a calibration. DC offset and gain calibrations take at least *N* + *TSETTLE* samples. AC offset calibrations take at least 6(*N*) + *TSETTLE* samples. As *N* is increased, the accuracy of calibration results tends to also increase.

The DRDY bit in the *Status* register will be set at the completion of Calibration commands. If an overflow occurs during calibration, other *Status* register bits may be set as well.

9.1.1 Offset Calibration

During offset calibrations, no line voltage or current should be applied to the meter. A zero-volt differential signal can also be applied to the voltage inputs $VIN_±$ or current inputs $IIN1± (IIN2±)$ of the CS5464.

(see [Figure 11](#page-38-6).)

Figure 11. System Calibration of Offset

9.1.1.1 DC Offset Calibration

The DC Offset Calibration command measures and averages DC values read on specified voltage or current channels at zero input and stores the inverse result in the associated offset registers. This will be added to instantaneous measurements in subsequent conversions, removing the offset.

Gain registers for channels being calibrated should be set to 1.0 prior to performing DC offset calibration.

9.1.1.2 AC Offset Calibration

The AC Offset Calibration command measures the residual RMS values read on specified voltage or current channels at zero input and stores the inverse result in the associated AC offset registers. This will be added to RMS measurements in subsequent conversions, removing the offset.

AC offset registers for channels being calibrated should first be cleared prior to performing the calibration.

Figure 10. Calibration Data Flow

9.1.2 Gain Calibration

During gain calibration, a full-scale reference signal must be applied to the meter or optionally, scaled to the VIN_{\pm} , IIN1 \pm (IIN2 \pm) pins of the CS5464. A DC reference must be used for DC gain calibration. Either an AC or DC reference can be used for RMS AC calibrations. If DC is used, the associated high-pass filter (HPF) must be off.

[Figure 12](#page-39-4) shows the basic setup for gain calibration.

Figure 12. System Calibration of Gain.

Using a reference that is too large or too small can cause an over-range condition during calibration. Either condition can set *Status* register bits I1OR (I2OR) V1OR (V2OR) for DC and I1ROR (I2ROR) V1ROR (V2ROR) for AC calibration.

Full scale (FS) for the voltage input is ±250mV peak and for the current inputs is ± 250 mV or ± 50 mV peak depending on selected gain range. The normal peak voltage applied to these pins should not exceed these levels during calibration or normal operation.

The range of the gain registers limits the gain calibration range and subsequently the range of the reference level that can be applied. The reference should not exceed FS or be lower than FS/4.

9.1.2.1 AC Gain Calibration

Full scale for AC RMS gain calibrations is 60% of the input's full-scale range, which is either 250mV or 50mV depending on the gain range selected. That's 150mV or 30mV, again depending on range. So the normal reference input level should be either 150 or 30 mV $_{RMS}$, AC or DC.

Prior to executing an AC Gain Calibration command, gain registers for any channel to be calibrated should be set to 1.0 if the reference level mentioned above is used, or to that level divided by the actual reference level used.

During AC gain calibration the RMS level of the applied reference is measured with the preset gain, then divided into 0.6 and the quotient stored back into the corresponding gain register.

9.1.2.2 DC Gain Calibration

With a DC reference applied, the DC Gain Calibration command measures and averages DC values read on the specified voltage or current channels and stores the reciprocal result in the associated gain registers, converting measured voltage into needed gain. Subsequent conversions will use the new gain value.

9.1.3 Calibration Order

- 1. DC offset.
- 2. DC or AC gain.
- 3. AC offset (if needed).

If both AC gain and offset calibrations were performed, it is possible to repeat both to obtain additional accuracy as AC gain and offset may interact.

9.1.4 Temperature Sensor Calibration

Temperature sensor calibration involves the adjustment of two parameters - Δ VBE and VBE0. These values must be known in order to calibrate the temperature sensor. See Section 6.13 *[Temperature Measurement](#page-20-1)* on page [21](#page-20-1) for an explanation of \triangle VBE and VBE0 and how to calculate *TGAIN* and *TOFF* register values from them.

9.1.4.1 Temperature Offset Calibration

Offset calibration can be done at any temperature, but should be done mid-scale if any gain error exists.

Subtract the measured *T* register temperature from the actual temperature to determine the offset error. Multiply this error by \triangle VBE and add it to VBE0 to yield a new VBE0 value. Recalculate *TOFF* using this new value*.*

9.1.4.2 Temperature Gain Calibration

Two temperature points far enough apart to give reasonable accuracy, for example 25°C and 85°C, are required to calibrate temperature gain.

Divide the actual temperature difference by the measured (*T* register) difference for the two temperatures. This gives a gain correction factor. Update the *TGAIN* register by multiplying it's value by this correction factor.

Update Δ VBE by dividing its old value by the gain correction factor. It will be needed for subsequent offset calibrations.

10.E2PROM OPERATION

The CS5464 can accept commands from a serial E²PROM connected to the serial interface instead of a host microcontroller. A high level (logic 1) on the MODE input indicates that an E^2 PROM is connected. This makes the \overline{CS} and SCLK pins become driven outputs. After reset and after running the initialization program, the CS5464 begins reading commands from the connected E²PROM.

10.1 E2PROM Configuration

A typical connection between the CS5464 and a E²PROM is shown in [Figure 13](#page-40-0).

The CS5464 asserts CS (logic 0), clocks SCLK, and sends Read commands to the E²PROM on SDO.

Command format is identical to microcontroller mode, except the CS5464 will not attempt to write to the EE device. The command sequence stops when the STOP bit in the Control register (*Ctrl*) is written by the command sequence.

Figure 13. Typical Interface of E2PROM to CS5464

[Figure 13](#page-40-0) also shows the external connections that would be made to a calibration device, such as a notebook computer, handheld calibrator, or tester during meter assembly, The calibrator or tester can be used to control the CS5464 during calibration and program the required values into the E^2 PROM.

10.2 E2PROM Code

The EEPROM code should do the following:

- 1. Set any Configuration or Control register bits, such as HPF enables and phase compensation settings.
- 2. Write any calibration data to gain and offset registers.
- 3. Set energy output pulse width, rate, and formats.
- 4. Execute a Continuous Conversion command.
- 5. Set the STOP bit in the Control register (last).

Below is an example E^2 PROM code set.

- **-**7E 00 00 01
- Change to page 1.
- **-**60 00 01 E0
- Write *Modes* Register, turn high-pass filters on. **-**42 7F C4 A9

Write value of 0x7FC4A9 to *I1GAIN* register.

-46 FF B2 53

Write value of 0xFFB253 to *V1GAIN* register. **-**50 7F C4 A9

Write value of 0x7FC4A9 to *I2GAIN* register. **-**54 FF B2 53

-
- Write value of 0xFFB253 to $V2_{GAIN}$ register.
- **-**7E 00 00 00

Change to page 0.

-74 00 00 04

Set LSD bit to 1 in the *Mask* register.

-E8

Start continuous conversions

-78 00 01 00

Write STOP bit to the Control register (*Ctrl*) to terminate E²PROM command sequence.

10.3 Which E2PROMs Can Be Used?

Several industry-standard serial E^2 PROMs can be used with the CS5464. Some are listed below:

- Atmel AT25010, AT25020 or AT25040
- National Semiconductor NM25C040M8 or NM25020M8
	- Xicor X25040SI

These serial E^2 PROMs expect a specific 8-bit command (00000011) in order to perform a memory read. The CS5464 has been hardware programmed to transmit this 8-bit command to the E^2 PROM after reset.

11. BASIC APPLICATION CIRCUITS

[Figure 14](#page-41-0) shows the CS5464 configured to measure power in a single-phase, 2-wire system while operating in a single-supply configuration. In this diagram, a shunt resistor is used to sense the line current and a voltage divider is used to sense the line voltage. In this type of shunt-resistor configuration, the common-mode level of the CS5464 must be referenced to the line side of the power line. This means that the common-mode potential of the CS5464 will track the high-voltage levels, as well as low-voltage levels, with respect to earth ground. Isolation circuitry is required when an earth-ground-referenced communication interface is connected. A current transformer (CT) is connected to the return line current, which implements the tamper detection circuit.

12. PACKAGE DIMENSIONS

28L SSOP PACKAGE DRAWING

JEDEC #: MO-150

Controlling Dimension is Millimeters

- Notes: 1. "D" and "E1" are reference datums and do not included mold flash or protrusions, but do include mold mismatch and are measured at the parting line, mold flash or protrusions shall not exceed 0.20 mm per side.
	- 2. Dimension "b" does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.13 mm total in excess of "b" dimension at maximum material condition. Dambar intrusion shall not reduce dimension "b" by more than 0.07 mm at least material condition.
	- 3. These dimensions apply to the flat section of the lead between 0.10 and 0.25 mm from lead tips.

13. ORDERING INFORMATION

14. ENVIRONMENTAL, MANUFACTURING, & HANDLING INFORMATION

* MSL (Moisture Sensitivity Level) as specified by IPC/JEDEC J-STD-020.

15. REVISION HISTORY

Contacting Cirrus Logic Support

[For all product questions and inquiries contact a Cirrus Logic Sales Representative.](http://www.cirrus.com)

[To find the one nearest to you go to w](http://www.cirrus.com)ww.cirrus.com

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